



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A																									
Supplier Information																																		
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer, David W	Contact Title	Staff Mfg & Process Dvl Engineer																											
Company Unique ID	TE Connectivity	Response Date	2018-04-05	Contact Email	dave.benfer@te.com																													
Contact Phone Number		+1-717-986-3725																																
Legal Statement																																		
Supplier Acceptance	true																																	
Legal Statement																																		
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.																																		
Product																																		
Manufacturer Item number	5227161-6	Amount	11284.513227	Version	-	Identity																												
Manufacturer Item Name	RTANG JK W/MTG PINS, BNC PCB	Weight Uom	mg	Mfr Site		Authority																												
Date		UOM	Each																															
EURoHS-0508	Product(s) meets EU RoHS requirements by application of the selected exemption(s)																																	
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products																																	
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH																																	
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed																																	
Product Disclosure																																		
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption																									
Sub-Item	1	MOUNTING POST, LEAD FREE PLATI				2.0	164.26	mg																										
Material	2	Nickel Plate				2.0	0.91	mg																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.00182	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	9.1E-4	mg																										
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.90727	mg																										
Material	2	Brass				2.0	161.36	mg																										
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	2.0	0.0016136	mg																										
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.016136	mg																										
Substance	3	Cobalt	Supplier	7440-48-4	0.1	2.0	0.16136	mg																										
Substance	3	Arsenic	Supplier	7440-38-2	0.01	2.0	0.016136	mg																										
Substance	3	Manganese	Supplier	7439-96-5	0.02	2.0	0.032272	mg																										
Substance	3	Chromium	Supplier	7440-47-3	0.0010	2.0	0.0016136	mg																										
Substance	3	Iron	Supplier	7439-89-6	0.35	2.0	0.56476	mg																										
Substance	3	Zinc	Supplier	7440-66-6	32.7475	2.0	52.84137	mg																										
Substance	3	Copper	Supplier	7440-50-8	63.0	2.0	101.6568	mg																										
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	8.068E-4	mg																										
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	2.0	0.016136	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	3.7	2.0	5.97032	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight																									
Substance	3	Nickel	Nickel	7440-02-0	0.05	2.0	0.08068	mg																										
Material	2	Tin Plate				2.0	1.99	mg																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.00398	mg																										
Substance	3	Tin	Supplier	7440-31-5	99.73	2.0	1.98463	mg																										

Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	2.0	0.001393	mg	
Sub-Item	1	CONTACT,BN C,LP,LEAD FREE PL				1.0	202.26	mg	
Material	2	Gold Plate				1.0	0.75	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	1.0	0.74775	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	1.0	0.00225	mg	
Material	2	Phos Bronze				1.0	198.0	mg	
Substance	3	Copper	Supplier	7440-50-8	94.6985	1.0	187.50303	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	1.0	0.0396	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	1.0	0.0198	mg	
Substance	3	Tin	Supplier	7440-31-5	4.5	1.0	8.91	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0050	1.0	0.0099	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	1.0	0.198	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0198	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	0.00198	mg	
Substance	3	Zinc	Supplier	7440-66-6	0.3	1.0	0.594	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	1.0	0.198	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	0.198	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	0.0099	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.099	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.1	1.0	0.198	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	9.9E-4	mg	
Material	2	Nickel Plate				1.0	3.29	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00658	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00329	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	3.28013	mg	
Material	2	Tin Plate				1.0	0.22	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	4.4E-4	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	0.21941	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	1.54E-4	mg	
Sub-Item	1	POST BNC PCB, LEAD-FREE, .869				1.0	77.234927	mg	
Material	2	Nickel Plate				1.0	0.850678	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00170136	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	8.5068E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	0.84813	mg	
Material	2	Brass Wire				1.0	74.758	mg	
Substance	3	Copper	Supplier	7440-50-8	71.5	1.0	53.45197	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	7.4758E-4	mg	
Substance	3	Zinc	Supplier	7440-66-6	28.0226	1.0	20.94914	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	1.0	0.037379	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	1.0	7.4758E-4	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	1.0	0.037379	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	0.074758	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	1.0	0.00740104	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0074758	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.037379	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	0.0037379	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	3.7379E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	1.0	0.14952	mg	
Material	2	Tin Plate				1.0	1.626249	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.0032525	mg	

Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	1.62186	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	0.00113837	mg	
Sub-Item	1	BNC,PCB,SHELL				1.0	6228.8714	mg	
Material	2	Zinc Alloy				1.0	6101.0	mg	
Substance	3	Silicon	Supplier	7440-21-3	0.035	1.0	2.13535	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.02	1.0	1.2202	mg	
Substance	3	Tin	Supplier	7440-31-5	0.0030	1.0	0.18303	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.06	1.0	3.6606	mg	
Substance	3	Copper	Supplier	7440-50-8	0.25	1.0	15.2525	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	1.0	0.6101	mg	
Substance	3	Zinc	Supplier	7440-66-6	95.0315	1.0	5797.87181	mg	
Substance	3	Aluminum	Supplier	7429-90-5	4.3	1.0	262.343	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.6101	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	0.06101	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	1.0	6.101	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	6.101	mg	
Substance	3	Magnesium	Supplier	7439-95-4	0.05	1.0	3.0505	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.02	1.0	1.2202	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0050	1.0	0.30505	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	0.030505	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0040	1.0	0.24404	mg	
Material	2	Nickel Plate				1.0	54.6	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.0546	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	54.4362	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.1092	mg	
Material	2	Tri Chrome Film				1.0	0.2264	mg	
Substance	3	Silicate(2-), hexafluoro-, hydrogen (1:2)	Supplier	16961-83-4	30.0	1.0	0.06792	mg	
Substance	3	Chromium chloride (CrCl3), hydrate (1:6)	Supplier	10060-12-5	60.0	1.0	0.13584	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	10.0	1.0	0.02264	mg	
Material	2	Copper Plate				1.0	73.045	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.073045	mg	
Substance	3	Copper	Supplier	7440-50-8	99.9	1.0	72.97195	mg	
Sub-Item	1	HOUSING,STD,JACK,PCB,BNC-TNC				1.0	4084.4	mg	
Material	2	PBT-GF15				1.0	4084.4	mg	
Substance	3	Carbon black	Supplier	1333-86-4	1.5	1.0	61.266	mg	
Substance	3	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	0.5	1.0	20.422	mg	
Substance	3	2-Propenenitrile, polymer with ethenylbenzene	Supplier	9003-54-7	0.4	1.0	16.3376	mg	
Substance	3	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	55.9	1.0	2283.1796	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	5.0	1.0	204.22	mg	
Substance	3	Acetic acid ethenyl ester, polymer with ethene	Supplier	24937-78-8	3.0	1.0	122.532	mg	
Substance	3	Phosphoric acid, zinc salt (2:3)	Supplier	7779-90-0	0.9	1.0	36.7596	mg	

Substance	3	Octadecanoic acid, 1,1-[2,2-bis[[1-oxooctadecyl)oxy)methyl]-1,3-propanediyl] ester	Supplier	115-83-3	0.5	1.0	20.422	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	17.0	1.0	694.348	mg	
Substance	3	Furan, tetrahydro-	Supplier	109-99-9	0.3	1.0	12.2532	mg	
Substance	3	Carbonic dichloride, polymer with 4,4-(1-methylethylidene)bis[2,6-dibromophenol] and phenol	Brominated Flame Retardants (other than PBBs or PBDEs)	94334-64-2	15.0	1.0	612.66	mg	
Sub-Item	1	DIELECTRIC, SER BNC				1.0	363.2269	mg	
Material	2	PMP				1.0	363.2269	mg	
Substance	3	1-Octadecene, polymer with 1-hexadecene and 4-methyl-1-pentene	Supplier	81229-87-0	99.0	1.0	359.59463	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	1.0	1.0	3.63227	mg	